# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

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MASARU IZAWA	06/18/2020
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## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16959099

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DATE SIGNED:	06/30/2020	

Total Attachments: 1

PATENT REEL: 053084 FRAME: 0784

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PATENT REEL: 053084 FRAME: 0785

# ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Tech Corporation, a corporation organized under the laws of Japan, located at 17-1, Toranomon 1-chome, Minate-ku, Tokyo 1058409, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Tech Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

#### PLASMA PROCESSING APPARATUS

invented by me (If only one is named below) or us (If plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Tech Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Tech Corporation.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (答名日)
1)	Isao Mon Jana Za	Jun. 16, 2020
2)	Masaru Izawa Mosawa Jawa	6/18/2020
3)	Nacki Yasui 744 44	6/18/2020
4)	Noriniko Ikeda Norihiko Ikeda	Jun. 18, 2020
5)	Kazuya Yamada Kazuya/ Yasaa da	Jun 16,2020
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7)		
3)		
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(0)		

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RECORDED: 06/30/2020